

PATENT ASSIGNMENT

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Hiroshi OSUGA	09/13/2011
Takaaki SUZUKI	09/13/2011
Atsushi KIUCHI	09/13/2011
Kazuhide KAWADE	09/14/2011
Hiroyuki HAMASAKI	09/13/2011
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Renesas Electronics Corporation
<b>Street Address:</b>	1753, Shimonumabe, Nakahara-ku,
<b>City:</b>	Kawasaki-shi, Kanagawa
<b>State/Country:</b>	JAPAN
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	13274324
<b>CORRESPONDENCE DATA</b>	
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<b>Total Attachments: 1</b> source=Assignment#page1.tif	

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ASSIGNMENT  
( 譲渡証 )

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Electronics Corporation, a corporation organized under the laws of Japan, located at 1753, Shimonumabe, Nakahara-ku, Kawasaki-shi, Kanagawa, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Electronics Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SEMICONDUCTOR INTEGRATED CIRCUIT AND MULTI-ANGLE VIDEO SYSTEM

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Renesas Electronics Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Electronics Corporation.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) <u>Hiroshi Osuga</u> Hiroshi OSUGA	<u>September 13, 2011</u>
2) <u>Takaaki Suzuki</u> Takaaki SUZUKI	<u>September 13, 2011</u>
3) <u>Atsushi Kiuchi</u> Atsushi KIUCHI	<u>September 13, 2011</u>
4) <u>Kazuhide Kawade</u> Kazuhide KAWADE	<u>September 14, 2011</u>
5) <u>Hiroyuki Hamasaki</u> Hiroyuki HAMASAKI	<u>September 13, 2011</u>
6) _____	_____
7) _____	_____
8) _____	_____
9) _____	_____
10) _____	_____